

In The United States Patent & Trademark In The United States Receiving Office (RO/US) For International Applications Filed Under The Patent Cooperation Treaty

In Re: Application of

YE, Hai et al.

International Application No.: PCT/US00/18188

International Filing Date: 30 June 2000

USSN: 10/019,032

Applicant Ref. No. AA484F

Applicants' Response to NOTIFICATION OF MISSING REQUIREMENTS UNDER 35 USC 371 IN THE UNITED STATES DESIGNATED/ELECTED OFFICE (DO/EO/US)

Assistant Commissioner for Patents Box PCT Washington, D.C. 20231

Dear Sir:

This supplies Applicants' response to the Notification of Missing Requirements Under 35 USC 371 in the United States Designated/Elected Office (Form PCT/DO/EO/905) mailed 25 February 2002. The response deadline is 25 April 2002.

FORM PCT/DO/EO/905 asserts, under Items 2 c) and d) that Applicant(s) are required to submit:

"Oath or Declaration of the inventors, in compliance with 37 CFR 1.63, identifying the application by International application number and international filing date". and

"Surcharge for providing the oath or declaration later than the appropriate 20 or 30 months from the priority date (37 CFR 1.492(e)).

Accompanying this response is a Declaration complying with the above-requirements. Please charge the requisite fees required under 37 CFR 1.492(e), and any additional fees associated with this response to Applicant(s) deposit account no. 16-2485. A copy of FORM PCT/DO/EO/905 is enclosed as required.

03/26/2002 MALI11 00000045 162485 01 FC:154 130.00 CH

Respectfully submitted for the Applicants

By:

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"Express Mail" mailing label number Date of Deposit: _

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I hereby certify that this paper/fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to BOX PCT, The Assistant Commissioner for Patents, Washington, DC 20231. Virginia By)d

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